Single 12-/10-/8-Bit SPI V_{OUT} DACs with 10ppm/°C Reference

FEATURES

- **Integrated Precision Reference**
  2.5V Full-Scale 10ppm/°C (LTC2640-L)
  4.096V Full-Scale 10ppm/°C (LTC2640-H)
- **Maximum INL Error: 1LSB (LTC2640A-12)**
- **Bidirectional Reference: Input or 10ppm/°C Output**
- **Low Noise (0.7mVpp, 0.1Hz to 200kHz)**
- Guaranteed Monotonic Over Temperature
- 2.7V to 5.5V Supply Range (LTC2640-L)
- Low Power Operation: 180µA at 3V
- Power Down to 1.8µA Maximum (C and I Grades)
- Asynchronous DAC Clear Pin (LTC2640-Z)
- Power-On Reset to Zero or Mid-Scale options
- Double-Buffered Data Latches
- Guaranteed Operation from –40°C to 125°C (H-Grade)
- 8-Lead TSOT-23 (ThinSOT™) Package

APPLICATIONS

- Mobile Communications
- Process Control and Industrial Automation
- Automatic Test Equipment
- Portable Equipment
- Automotive
- Optical Networking

DESCRIPTION

The LTC®2640 is a family of 12-, 10-, and 8-bit voltage-output DACs with an integrated, high-accuracy, low-drift reference in an 8-lead TSOT-23 package. It has a rail-to-rail output buffer that is guaranteed monotonic.

The LTC2640-L has a full-scale output of 2.5V, and operates from a single 2.7V to 5.5V supply. The LTC2640-H has a full-scale output of 4.096V, and operates from a 4.5V to 5.5V supply. A 10ppm/°C reference output is available at the REF pin.

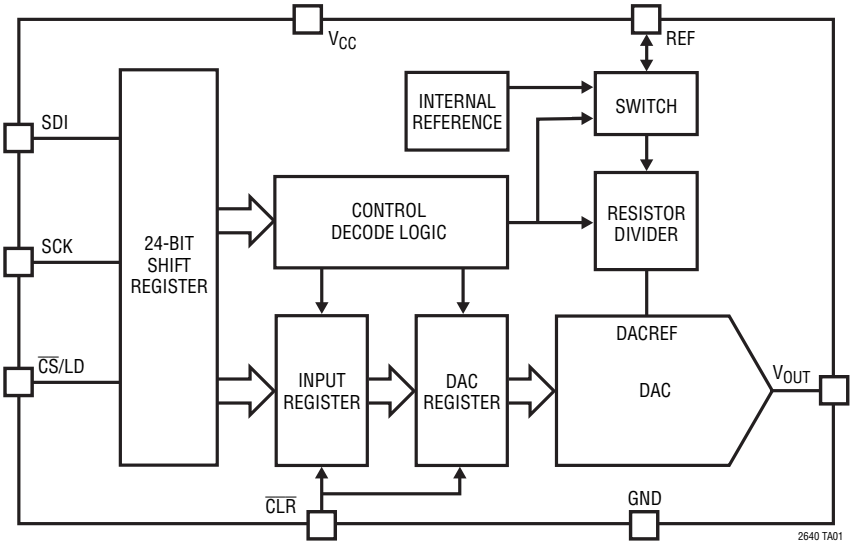
Each DAC can also operate in External Reference mode, in which a voltage supplied to the REF pin sets the full-scale output.

The LTC2640 DACs use a SPI/MICROWIRE™ compatible 3-wire serial interface which operates at clock rates up to 50MHz.

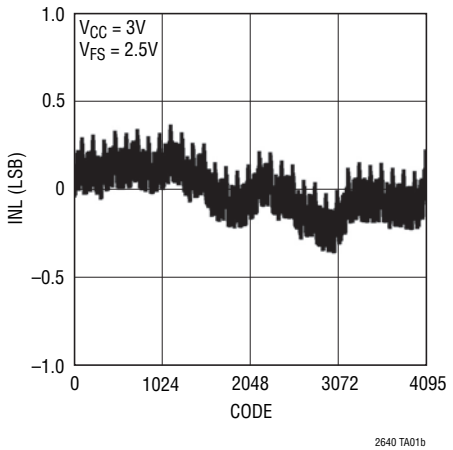
The LTC2640 incorporates a power-on reset circuit. Options are available for Reset to Zero-Scale or Reset to Mid-Scale after power-up.

LT, LTC, LTM, Linear Technology and the Linear logo are registered trademarks and ThinSOT is a trademark of Linear Technology Corporation. All other trademarks are the property of their respective owners. Protected by U.S. Patents, including 5396245, 5859606, 6891433, 6937178 and 7414561.

BLOCK DIAGRAM (LTC2640-Z)



Integral Nonlinearity (LTC2640A-LZ12)



ABSOLUTE MAXIMUM RATINGS

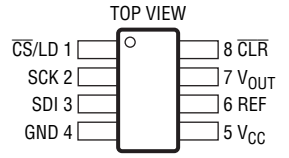
(Notes 1, 2)

Supply Voltage (V_{CC}) ..... –0.3V to 6V
$\overline{CLR}$, $\overline{CS}$/LD, REF_SEL, SCK, SDI ..... –0.3V to 6V
V_{OUT}, REF ..... –0.3V to Min(V_{CC} + 0.3V, 6V)
Operating Temperature Range
LTC2640C ..... 0°C to 70°C
LTC2640I ..... –40°C to 85°C
LTC2640H (Note 3) ..... –40°C to 125°C

Maximum Junction Temperature ..... 150°C
Storage Temperature Range ..... –65°C to 150°C
Lead Temperature (Soldering, 10 sec)..... 300°C

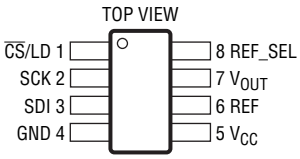
PIN CONFIGURATION

LTC2640-Z



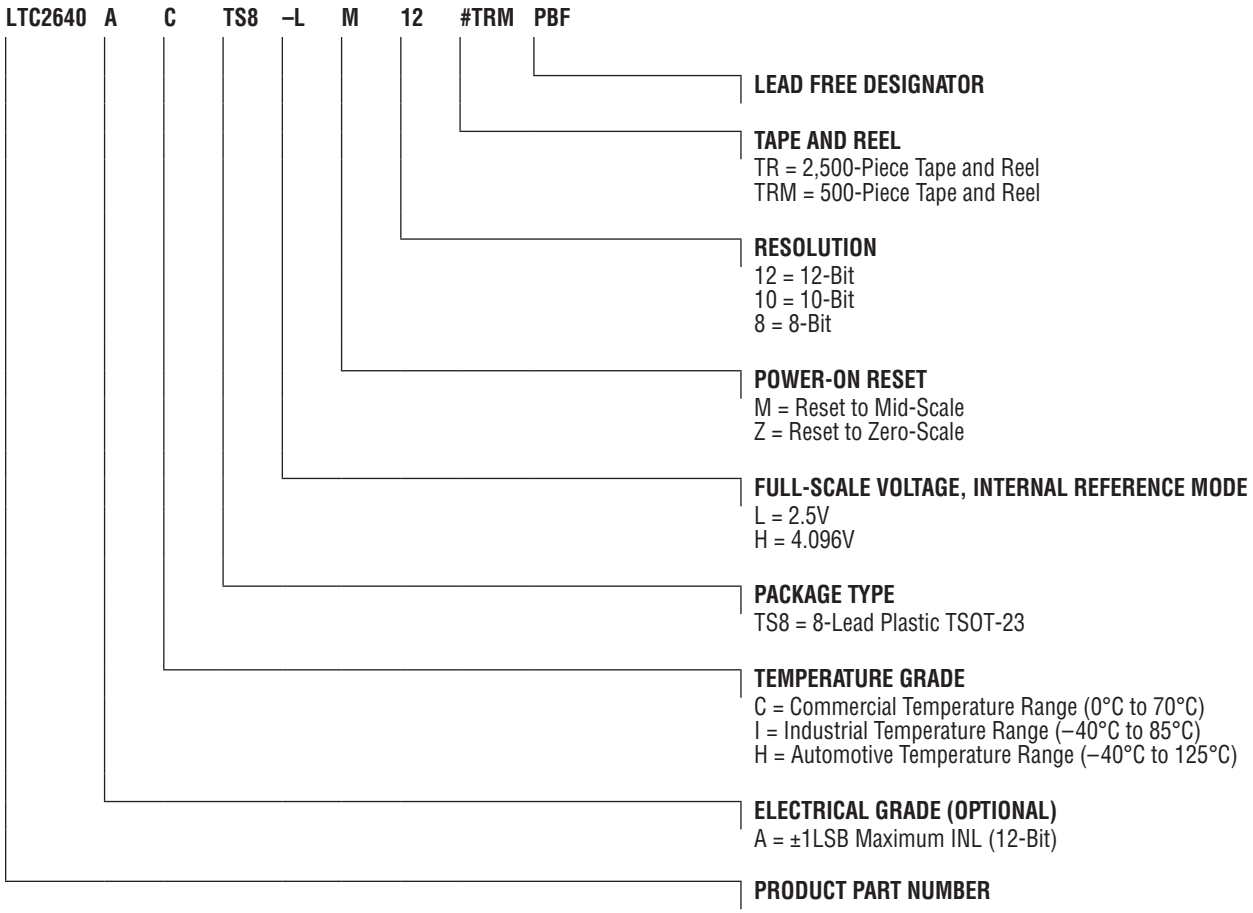
TS8 PACKAGE
8-LEAD PLASTIC TSOT-23
T_{JMAX} = 150°C (NOTE 6), θ_{JA} = 195°C/W

LTC2640-M



TS8 PACKAGE
8-LEAD PLASTIC TSOT-23
T_{JMAX} = 150°C (NOTE 6), θ_{JA} = 195°C/W

ORDER INFORMATION



Consult LTC Marketing for information on non-standard lead based finish parts.

For more information on lead free part marking, go to: http://www.linear.com/leadfree/
For more information on tape and reel specifications, go to: http://www.linear.com/tapeandreel/

PRODUCT SELECTION GUIDE

PART NUMBER	PART MARKING*	V_{FS} WITH INTERNAL REFERENCE	POWER-ON RESET TO CODE	PIN 8	RESOLUTION	V_{CC}	MAXIMUM INL
LTC2640A-LM12	LTDHV	2.5V • (4095/4096)	Mid-Scale	REF_SEL	12-Bit	2.7V – 5.5V	±1LSB
LTC2640A-LZ12	LTDHW	2.5V • (4095/4096)	Zero	$\overline{CLR}$	12-Bit	2.7V – 5.5V	±1LSB
LTC2640A-HM12	LTDHX	4.096V • (4095/4096)	Mid-Scale	REF_SEL	12-Bit	4.5V – 5.5V	±1LSB
LTC2640A-HZ12	LTDHY	4.096V • (4095/4096)	Zero	$\overline{CLR}$	12-Bit	4.5V – 5.5V	±1LSB
LTC2640-LM12	LTDHV	2.5V • (4095/4096)	Mid-Scale	REF_SEL	12-Bit	2.7V – 5.5V	±2.5LSB
LTC2640-LM10	LTDHZ	2.5V • (1023/1024)	Mid-Scale	REF_SEL	10-Bit	2.7V – 5.5V	±1LSB
LTC2640-LM8	LTDJF	2.5V • (255/256)	Mid-Scale	REF_SEL	8-Bit	2.7V – 5.5V	±0.5LSB
LTC2640-LZ12	LTDHW	2.5V • (4095/4096)	Zero	$\overline{CLR}$	12-Bit	2.7V – 5.5V	±2.5LSB
LTC2640-LZ10	LTDJB	2.5V • (1023/1024)	Zero	$\overline{CLR}$	10-Bit	2.7V – 5.5V	±1LSB
LTC2640-LZ8	LTDJG	2.5V • (255/256)	Zero	$\overline{CLR}$	8-Bit	2.7V – 5.5V	±0.5LSB
LTC2640-HM12	LTDHX	4.096V • (4095/4096)	Mid-Scale	REF_SEL	12-Bit	4.5V – 5.5V	±2.5LSB
LTC2640-HM10	LTDJC	4.096V • (1023/1024)	Mid-Scale	REF_SEL	10-Bit	4.5V – 5.5V	±1LSB
LTC2640-HM8	LTDJH	4.096V • (255/256)	Mid-Scale	REF_SEL	8-Bit	4.5V – 5.5V	±0.5LSB
LTC2640-HZ12	LTDHY	4.096V • (4095/4096)	Zero	$\overline{CLR}$	12-Bit	4.5V – 5.5V	±2.5LSB
LTC2640-HZ10	LTDJD	4.096V • (1023/1024)	Zero	$\overline{CLR}$	10-Bit	4.5V – 5.5V	±1LSB
LTC2640-HZ8	LTDJJ	4.096V • (255/256)	Zero	$\overline{CLR}$	8-Bit	4.5V – 5.5V	±0.5LSB

*The temperature grade is identified by a label on the shipping container.

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{CC} = 2.7V to 5.5V, V_{OUT} unloaded unless otherwise specified.

LTC2640-LM12/-LM10/-LM8/-LZ12/-LZ10/-LZ8, LTC2640A-LM12/-LZ12 (V_{FS} = 2.5V)

SYMBOL	PARAMETER	CONDITIONS		LTC2640-8 MIN	LTC2640-8 TYP	LTC2640-8 MAX	LTC2640-10 MIN	LTC2640-10 TYP	LTC2640-10 MAX	LTC2640-12 MIN	LTC2640-12 TYP	LTC2640-12 MAX	LTC2640A-12 MIN	LTC2640A-12 TYP	LTC2640A-12 MAX	UNITS
DC Performance																
	Resolution		●	8			10			12			12			Bits
	Monotonicity	V_{CC} = 3V, Internal Ref. (Note 4)	●	8			10			12			12			Bits
DNL	Differential Nonlinearity	V_{CC} = 3V, Internal Ref. (Note 4)	●			±0.5			±0.5			±1			±1	LSB
INL	Integral Nonlinearity	V_{CC} = 3V, Internal Ref. (Note 4)	●		±0.05	±0.5		±0.2	±1		±1	±2.5		±0.5	±1	LSB
ZSE	Zero-Scale Error	V_{CC} = 3V, Internal Ref., Code = 0	●		0.5	5		0.5	5		0.5	5		0.5	5	mV
V_{OS}	Offset Error	V_{CC} = 3V, Internal Ref. (Note 5)	●		±0.5	±5		±0.5	±5		±0.5	±5		±0.5	±5	mV
V_{OSTC}	V_{OS} Temperature Coefficient	V_{CC} = 3V, Internal Ref. (Note 5)			±10			±10			±10			±10		µV/°C
FSE	Full-Scale Error	V_{CC} = 3V, Internal Ref. (Note 11)	●		±0.08	±0.4		±0.08	±0.4		±0.08	±0.4		±0.08	±0.4	%FSR
V_{FSTC}	Full-Scale Voltage Temperature Coefficient	V_{CC} = 3V, Internal Ref. (Note 10) C-Grade I-Grade H-Grade			 ±10 ±10 ±10			 ±10 ±10 ±10			 ±10 ±10 ±10			 ±10 ±10 ±10		 ppm/°C ppm/°C ppm/°C
	Load Regulation	Internal Ref., Mid-Scale, V_{CC} = 3V ±10%, –5mA ≤ I_{OUT} ≤ 5mA, V_{CC} = 5V ±10%, –10mA ≤ I_{OUT} ≤ 10mA	 ● ●		 0.009 0.009	 0.016 0.016		 0.035 0.035	 0.064 0.064		 0.14 0.14	 0.256 0.256		 0.14 0.14	 0.256 0.256	 LSB/mA LSB/mA
R_{OUT}	DC Output Impedance	Internal Ref., Mid-Scale, V_{CC} = 3V ±10%, –5mA ≤ I_{OUT} ≤ 5mA, V_{CC} = 5V ±10%, –10mA ≤ I_{OUT} ≤ 10mA	 ● ●		 0.09 0.09	 0.156 0.156		 0.09 0.09	 0.156 0.156		 0.09 0.09	 0.156 0.156		 0.09 0.09	 0.156 0.156	 Ω Ω

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V_{OUT}	DAC Output Span	External Reference Internal Reference			0 to V_{REF} 0 to 2.5		V V
PSR	Power Supply Rejection	V_{CC} = 3V ±10% or 5V ±10%			–80		dB
I_{SC}	Short-Circuit Output Current (Note 6) Sinking Sourcing	V_{FS} = V_{CC} = 5.5V Zero-Scale; V_{OUT} shorted to V_{CC} Full-Scale; V_{OUT} shorted to GND	 ● ●		 27 –28	 48 –48	 mA mA
Power Supply							
V_{CC}	Positive Supply Voltage	For Specified Performance	●	2.7		5.5	V
I_{CC}	Supply Current (Note 7)	V_{CC} = 3V, V_{REF} = 2.5V, External Reference V_{CC} = 3V, Internal Reference V_{CC} = 5V, V_{REF} = 2.5V, External Reference V_{CC} = 5V, Internal Reference	● ● ● ●		150 180 160 190	200 240 210 260	µA µA µA µA
I_{SD}	Supply Current in Power-Down Mode (Note 7)	V_{CC} = 5V, C-Grade, I-Grade V_{CC} = 5V, H-Grade	● ●		0.6 0.6	1.8 4	µA µA

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{CC} = 2.7V to 5.5V, V_{OUT} unloaded unless otherwise specified.

LTC2640-LM12/-LM10/-LM8/-LZ12/-LZ10/-LZ8, LTC2640A-LM12/-LZ12 (V_{FS} = 2.5V)

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Reference Input							
	Input Voltage Range		●	0		V_{CC}	V
	Resistance		●	160	190	220	kΩ
	Capacitance				7.5		pF
I_{REF}	Reference Current, Power-Down Mode	DAC Powered Down	●		0.005	0.1	µA
Reference Output							
	Output Voltage		●	1.240	1.250	1.260	V
	Reference Temperature Coefficient				±10		ppm/°C
	Output Impedance				0.5		kΩ
	Capacitive Load Driving				10		µF
	Short-Circuit Current	V_{CC} = 5.5V; REF Shorted to GND			2.5		mA
Digital I/O							
V_{IH}	Digital Input High Voltage	V_{CC} = 3.6V to 5.5V V_{CC} = 2.7V to 3.6V	● ●	2.4 2			V V
V_{IL}	Digital Input Low Voltage	V_{CC} = 4.5V to 5.5V V_{CC} = 2.7V to 4.5V	● ●			0.8 0.6	V V
I_{LK}	Digital Input Leakage	V_{IN} = GND to V_{CC}	●			±1	µA
C_{IN}	Digital Input Capacitance	(Note 8)	●			2.5	pF
AC Performance							
t_S	Settling Time	V_{CC} = 3V (Note 9) ±0.39% (±1LSB at 8-Bits) ±0.098% (±1LSB at 10-Bits) ±0.024% (±1LSB at 12-Bits)			 3.2 3.8 4.1		 µs µs µs
	Voltage Output Slew Rate				1		V/µs
	Capacitance Load Driving				500		pF
	Glitch Impulse	At Mid-Scale Transition			2.1		nV•s
	Multiplying Bandwidth	External Reference			300		kHz
e_n	Output Voltage Noise Density	At f = 1kHz, External Reference At f = 10kHz, External Reference At f = 1kHz, Internal Reference At f = 10kHz, Internal Reference			140 130 160 150		$nV/\sqrt{Hz}$ $nV/\sqrt{Hz}$ $nV/\sqrt{Hz}$ $nV/\sqrt{Hz}$
	Output Voltage Noise	0.1Hz to 10Hz, External Reference 0.1Hz to 10Hz, Internal Reference 0.1Hz to 200kHz, External Reference 0.1Hz to 200kHz, Internal Reference, C_{REF} = 0.33µF			20 20 650 670		$µV_{P-P}$ $µV_{P-P}$ $µV_{P-P}$ $µV_{P-P}$

TIMING CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{CC} = 2.7V to 5.5V. (See Figure 1) (Note 8).

LTC2640-LM12/-LM10/-LM8/-LZ12/-LZ10/-LZ8, LTC2640A-LM12/-LZ12 (V_{FS} = 2.5V)

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
t_1	SDI Valid to SCK Setup		●	4			ns
t_2	SDI Valid to SCK Hold		●	4			ns
t_3	SCK High Time		●	9			ns
t_4	SCK Low Time		●	9			ns
t_5	$\overline{CS}$/LD Pulse Width		●	10			ns
t_6	LSB SCK High to $\overline{CS}$/LD High		●	7			ns
t_7	$\overline{CS}$/LD Low to SCK High		●	7			ns
t_9	$\overline{CLR}$ Pulse Width		●	20			ns
t_{10}	$\overline{CS}$/LD High to SCK Pos. Edge		●	7			ns
	SCK Frequency	50% Duty Cycle	●			50	MHz

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{CC} = 4.5V to 5.5V, V_{OUT} unloaded unless otherwise specified.

LTC2640-HM12/-HM10/-HM8/-HZ12/-HZ10/-HZ8, LTC2640A-HM12/-HZ12 (V_{FS} = 4.096V)

				LTC2640-8			LTC2640-10			LTC2640-12			LTC2640A-12			
SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
DC Performance																
	Resolution		●	8			10			12			12			Bits
	Monotonicity	V_{CC} = 5V, Internal Ref. (Note 4)	●	8			10			12			12			Bits
DNL	Differential Nonlinearity	V_{CC} = 5V, Internal Ref. (Note 4)	●			±0.5			±0.5			±1			±1	LSB
INL	Integral Nonlinearity	V_{CC} = 5V, Internal Ref. (Note 4)	●		±0.05	±0.5		±0.2	±1		±1	±2.5		±0.5	±1	LSB
ZSE	Zero-Scale Error	V_{CC} = 5V, Internal Ref., Code = 0	●		0.5	5		0.5	5		0.5	5		0.5	5	mV
V_{OS}	Offset Error	V_{CC} = 5V, Internal Ref. (Note 5)	●		±0.5	±5		±0.5	±5		±0.5	±5		±0.5	±5	mV
V_{OSTC}	V_{OS} Temperature Coefficient	V_{CC} = 5V, Internal Ref. (Note 5)			±10			±10			±10			±10		µV/°C
FSE	Full-Scale Error	V_{CC} = 5V, Internal Ref. (Note 11)	●		±0.08	±0.4		±0.08	±0.4		±0.08	±0.4		±0.08	±0.4	%FSR
V_{FSTC}	Full-Scale Voltage Temperature Coefficient	V_{CC} = 5V, Internal Ref. (Note 10) C-Grade I-Grade H-Grade			 ±10 ±10 ±10			 ±10 ±10 ±10			 ±10 ±10 ±10			 ±10 ±10 ±10		 ppm/°C ppm/°C ppm/°C
	Load Regulation	V_{CC} = 5V ±10%, Internal Ref. Mid-Scale, –10mA ≤ I_{OUT} ≤ 10mA	●		0.006	0.01		0.022	0.04		0.09	0.16		0.09	0.16	LSB/mA
R_{OUT}	DC Output Impedance	V_{CC} = 5V ±10%, Internal Ref. Mid-Scale, –10mA ≤ I_{OUT} ≤ 10mA	●		0.09	0.156		0.09	0.156		0.09	0.156		0.09	0.156	Ω

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{CC} = 4.5V to 5.5V, V_{OUT} unloaded unless otherwise specified.

LTC2640-HM12/-HM10/-HM8/-HZ12/-HZ10/-HZ8, LTC2640A-HM12/-HZ12 (V_{FS} = 4.096V)

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V_{OUT}	DAC Output Span	External Reference Internal Reference			0 to V_{REF} 0 to 4.096		V V
PSR	Power Supply Rejection	V_{CC} = 5V ±10%			–80		dB
I_{SC}	Short-Circuit Output Current (Note 6) Sinking Sourcing	V_{FS} = V_{CC} = 5.5V Zero-Scale; V_{OUT} shorted to V_{CC} Full-Scale; V_{OUT} shorted to GND	 ● ●		 27 –28	 48 –48	 mA mA
Power Supply							
V_{CC}	Positive Supply Voltage	For Specified Performance	●	4.5		5.5	V
I_{CC}	Supply Current (Note 7)	V_{CC} = 5V, V_{REF} = 4.096V, External Reference V_{CC} = 5V, Internal Reference	● ●		160 200	220 270	µA µA
I_{SD}	Supply Current in Power-Down Mode (Note 7)	V_{CC} = 5V, C-Grade, I-Grade V_{CC} = 5V, H-Grade	● ●		0.6 0.6	1.8 4	µA µA
Reference Input							
	Input Voltage Range		●	0		V_{CC}	V
	Resistance		●	160	190	220	kΩ
	Capacitance				7.5		pF
I_{REF}	Reference Current, Power-Down Mode	DAC Powered Down	●		0.005	0.1	µA
Reference Output							
	Output Voltage		●	2.032	2.048	2.064	V
	Reference Temperature Coefficient				±10		ppm/°C
	Output Impedance				0.5		kΩ
	Capacitive Load Driving				10		µF
	Short-Circuit Current	V_{CC} = 5.5V; REF Shorted to GND			4.3		mA
Digital I/O							
V_{IH}	Digital Input High Voltage		●	2.4			V
V_{IL}	Digital Input Low Voltage		●			0.8	V
I_{LK}	Digital Input Leakage	V_{IN} = GND to V_{CC}	●			±1	µA
C_{IN}	Digital Input Capacitance	(Note 8)	●			2.5	pF
AC Performance							
t_S	Settling Time	V_{CC} = 5V (Note 9) ±0.39% (±1LSB at 8 Bits) ±0.098% (±1LSB at 10 Bits) ±0.024% (±1LSB at 12 Bits)			 3.7 4.2 4.6		 µs µs µs
	Voltage Output Slew Rate				1		V/µs
	Capacitance Load Driving				500		pF
	Glitch Impulse	At Mid-Scale Transition			3.0		nV•s
	Multiplying Bandwidth	External Reference			300		kHz

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{CC} = 4.5V to 5.5V, V_{OUT} unloaded unless otherwise specified.

LTC2640-HM12/-HM10/-HM8/-HZ12/-HZ10/-HZ8, LTC2640A-HM12/-HZ12 (V_{FS} = 4.096V)

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
e_n	Output Voltage Noise Density	At f = 1kHz, External Reference At f = 10kHz, External Reference At f = 1kHz, Internal Reference At f = 10kHz, Internal Reference			140 130 210 200		$nV\sqrt{Hz}$ $nV\sqrt{Hz}$ $nV\sqrt{Hz}$ $nV\sqrt{Hz}$
	Output Voltage Noise	0.1Hz to 10Hz, External Reference 0.1Hz to 10Hz, Internal Reference 0.1Hz to 200kHz, External Reference 0.1Hz to 200kHz, Internal Reference, C_{REF} = 0.33µF			20 20 650 670		$µV_{P-P}$ $µV_{P-P}$ $µV_{P-P}$ $µV_{P-P}$

TIMING CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{CC} = 4.5V to 5.5V. (See Figure 1) (Note 8).

LTC2640-HM12/-HM10/-HM8/-HZ12/-HZ10/-HZ8, LTC2640A-HM12/-HZ12 (V_{FS} = 4.096V)

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
t_1	SDI Valid to SCK Setup		●	4			ns
t_2	SDI Valid to SCK Hold		●	4			ns
t_3	SCK High Time		●	9			ns
t_4	SCK Low Time		●	9			ns
t_5	$\overline{CS}$/LD Pulse Width		●	10			ns
t_6	LSB SCK High to $\overline{CS}$/LD High		●	7			ns
t_7	$\overline{CS}$/LD Low to SCK High		●	7			ns
t_9	$\overline{CLR}$ Pulse Width		●	20			ns
t_{10}	$\overline{CS}$/LD High to SCK Pos. Edge		●	7			ns
	SCK Frequency	50% Duty Cycle	●			50	MHz

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: All voltages are with respect to GND.

Note 3: High temperatures degrade operating lifetimes. Operating lifetime is derated at temperatures greater than 105°C.

Note 4: Linearity and monotonicity are defined from code k_L to code $2^N - 1$, where N is the resolution and k_L is given by $k_L = 0.016 \bullet (2^N / V_{FS})$, rounded to the nearest whole code. For V_{FS} = 2.5V and N = 12, k_L = 26 and linearity is defined from code 26 to code 4,095. For V_{FS} = 4.096V and N = 12, k_L = 16 and linearity is defined from code 16 to code 4,095.

Note 5: Inferred from measurement at code 16 (LTC2640-12), code 4 (LTC2640-10) or code 1 (LTC2640-8), and at full-scale.

Note 6: This IC includes current limiting that is intended to protect the device during momentary overload conditions. Junction temperature can exceed the rated maximum during current limiting. Continuous operation above the specified maximum operating junction temperature may impair device reliability.

Note 7: Digital inputs at 0V or V_{CC}.

Note 8: Guaranteed by design and not production tested.

Note 9: Internal Reference mode. DAC is stepped 1/4 scale to 3/4 scale and 3/4 scale to 1/4 scale. Load is 2k in parallel with 100pF to GND.

Note 10: Temperature coefficient is calculated by dividing the maximum change in output voltage by the specified temperature range.

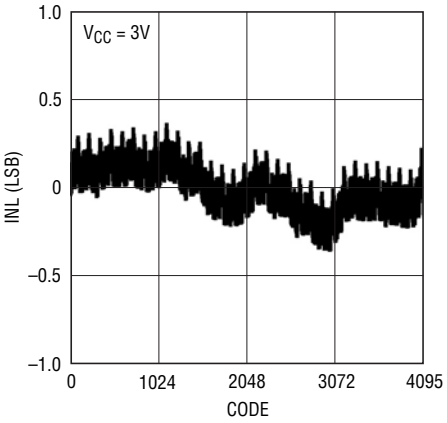
Note 11: Full-scale error is determined using the reference voltage measured at the REF pin.

TYPICAL PERFORMANCE CHARACTERISTICS

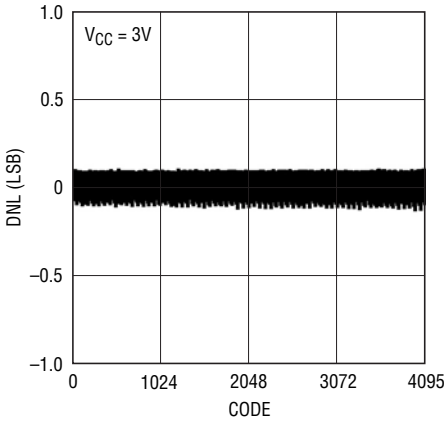
T_A = 25°C, unless otherwise noted.

LTC2640-L12 (Internal Reference, V_{FS} = 2.5V)

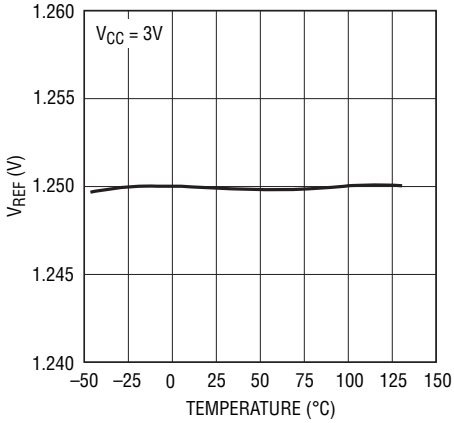
Integral Nonlinearity (INL)



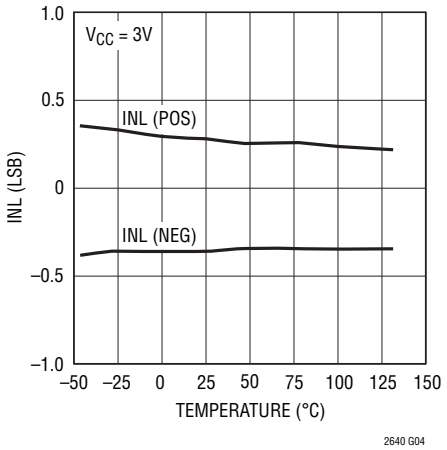
Differential Nonlinearity (DNL)



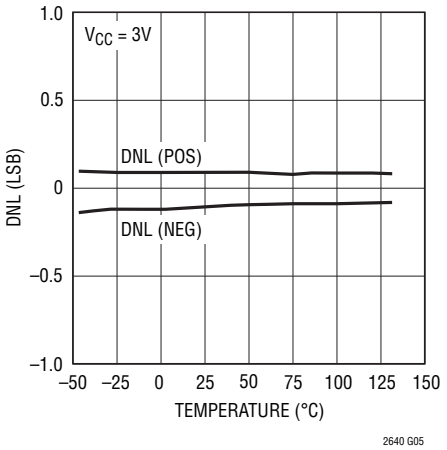
Reference Output Voltage vs Temperature



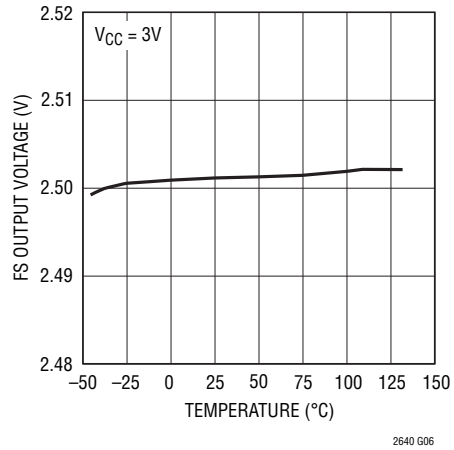
INL vs Temperature



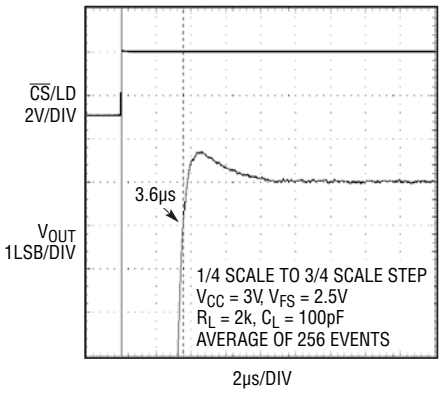
DNL vs Temperature



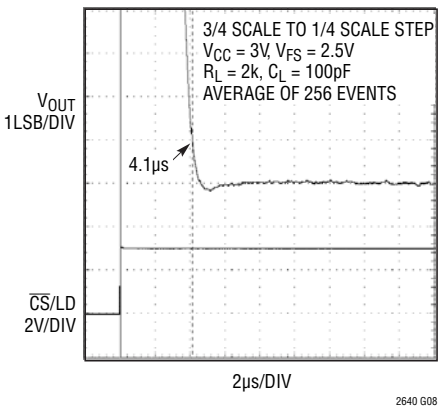
Full-Scale Output Voltage vs Temperature



Settling to ±1LSB



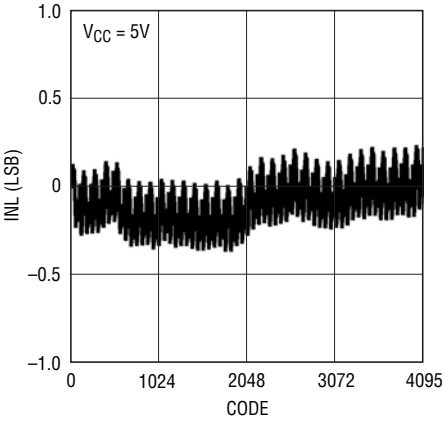
Settling to ±1LSB



TYPICAL PERFORMANCE CHARACTERISTICS T_A = 25°C, unless otherwise noted.

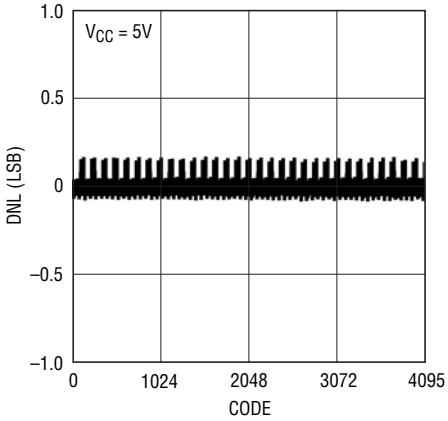
LTC2640-H12 (Internal Reference, V_{FS} = 4.096V)

Integral Nonlinearity (INL)



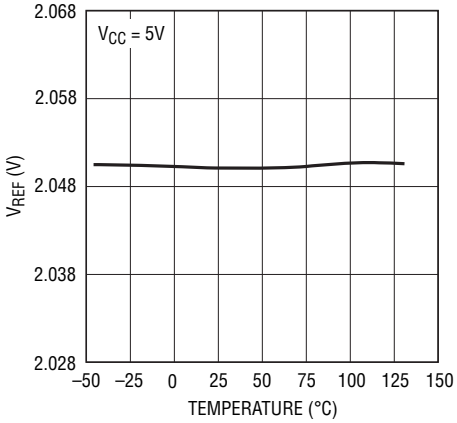
2640 G09

Differential Nonlinearity (DNL)



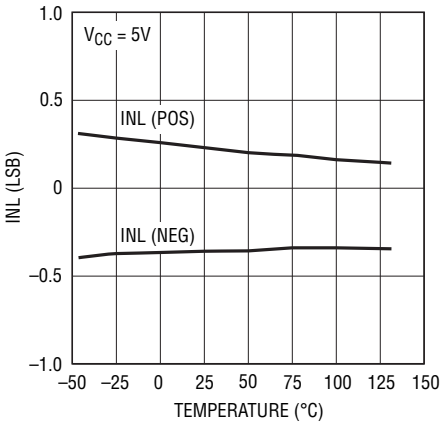
2640 G10

Reference Output Voltage vs Temperature



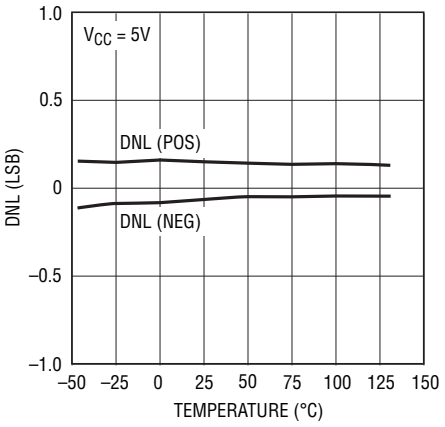
2640 G11

INL vs Temperature



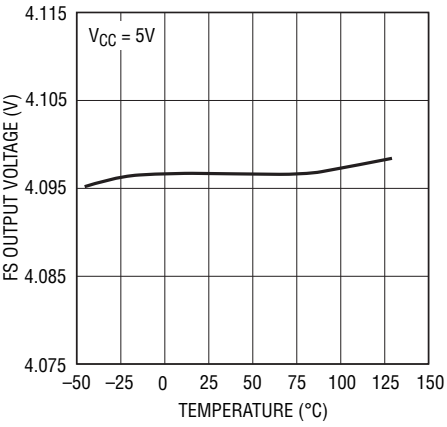
2640 G12

DNL vs Temperature



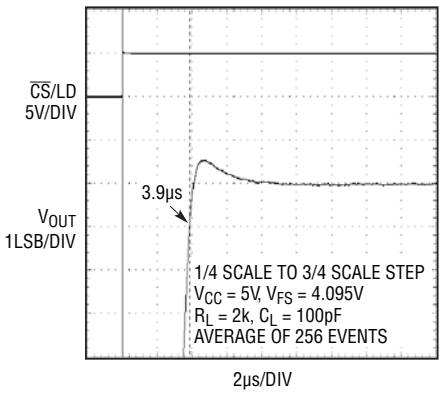
2640 G13

Full-Scale Output Voltage vs Temperature



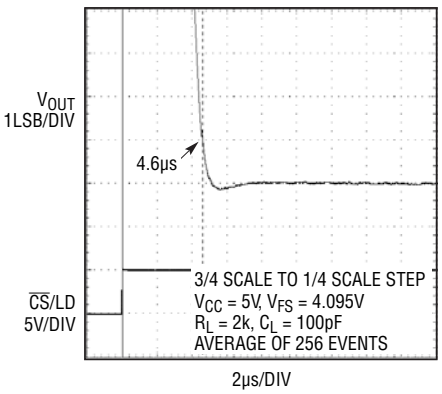
2640 G14

Settling to ±1LSB



2640 G15

Settling to ±1LSB

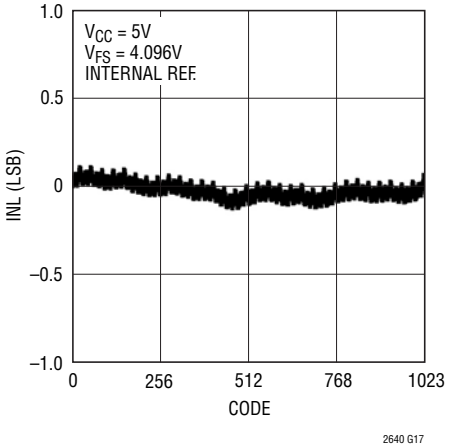


2640 G16

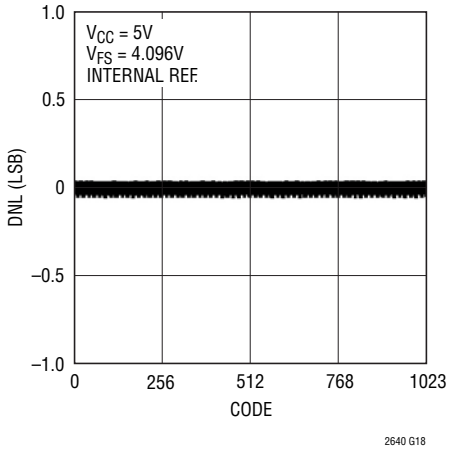
TYPICAL PERFORMANCE CHARACTERISTICS T_A = 25°C, unless otherwise noted.

LTC2640-10

Integral Nonlinearity (INL)

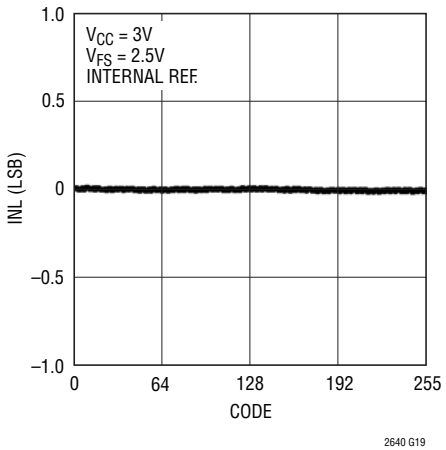


Differential Nonlinearity (DNL)

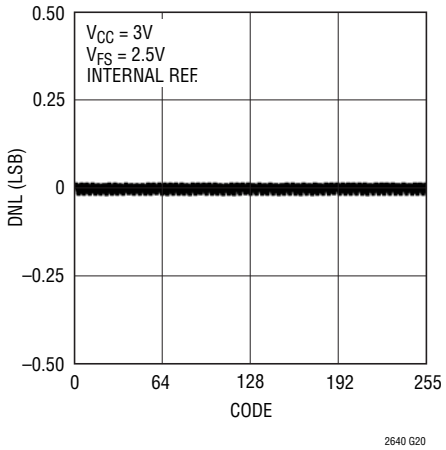


LTC2640-8

Integral Nonlinearity (INL)

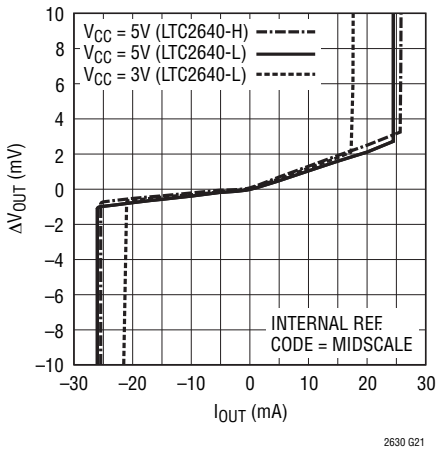


Differential Nonlinearity (DNL)

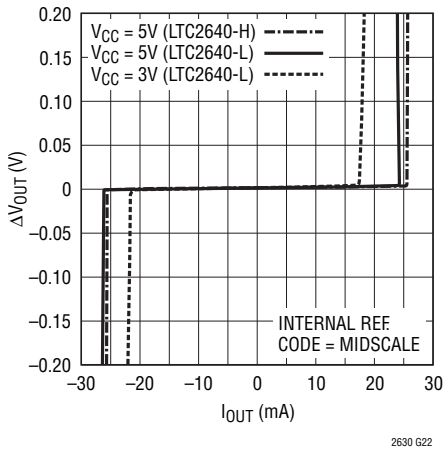


LTC2640

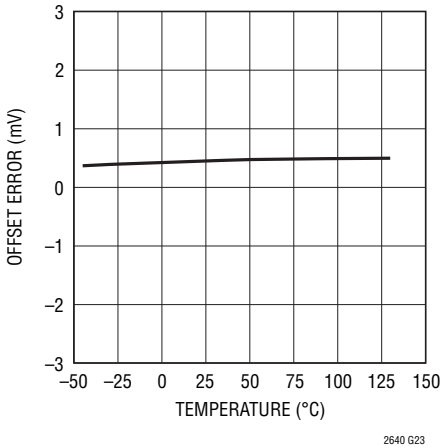
Load Regulation



Current Limiting



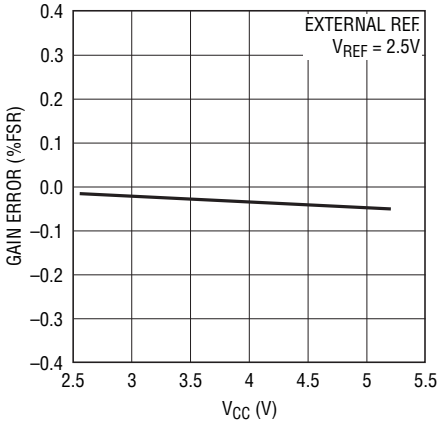
Offset Error vs Temperature



TYPICAL PERFORMANCE CHARACTERISTICS T_A = 25°C, unless otherwise noted.

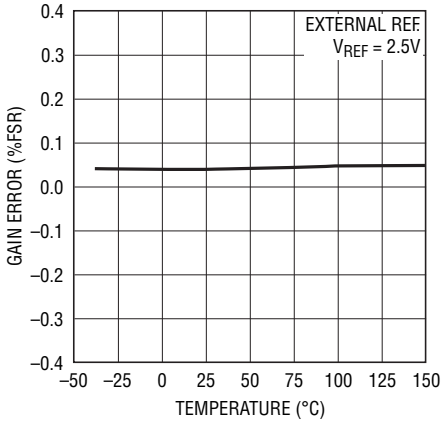
LTC2640

Gain Error vs V_{CC}



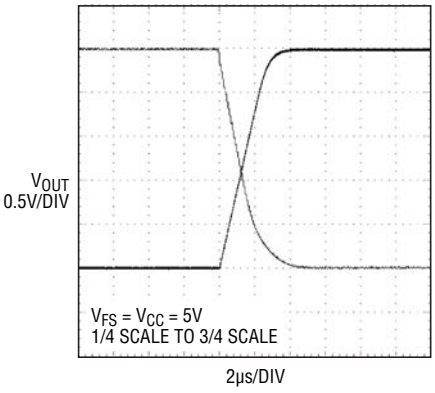
2640 G24

Gain Error vs Temperature



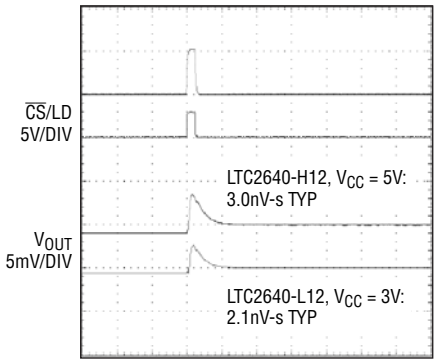
2640 G25

Large-Signal Response



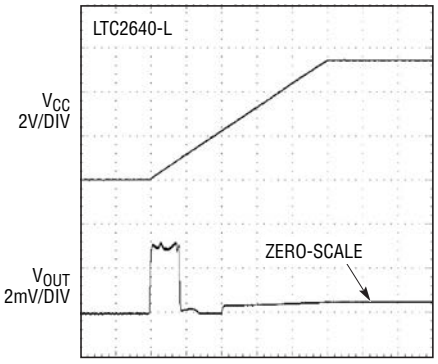
2640 G26

Mid-Scale-Glitch Impulse



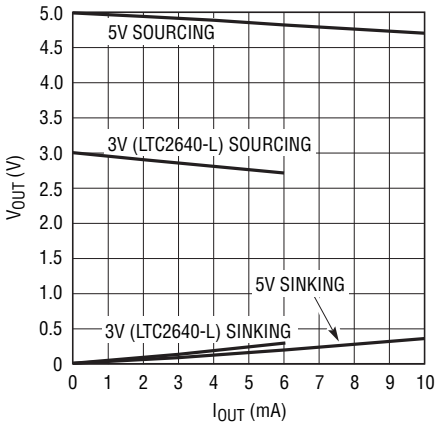
2640 G27

Power-On Reset Glitch



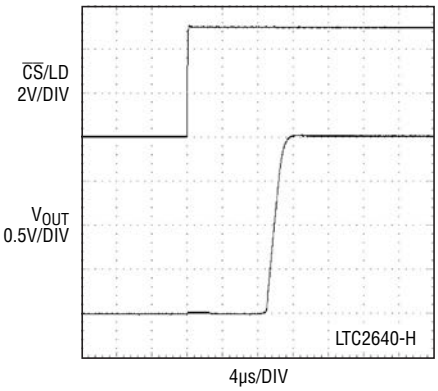
2640 G28

Headroom at Rails vs Output Current



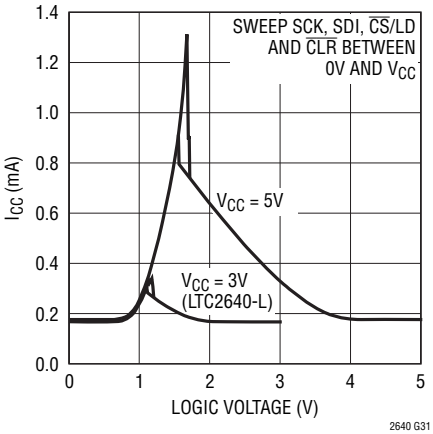
2640 G29

Exiting Power-Down to Mid-Scale



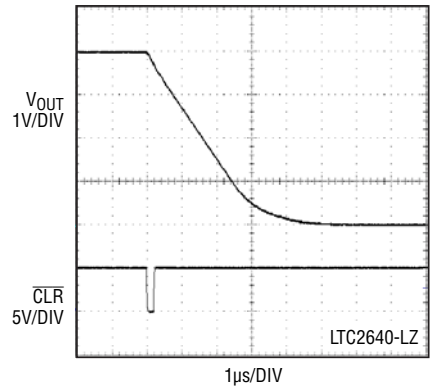
2640 G30

Supply Current vs Logic Voltage



2640 G31

Hardware $\overline{CLR}$



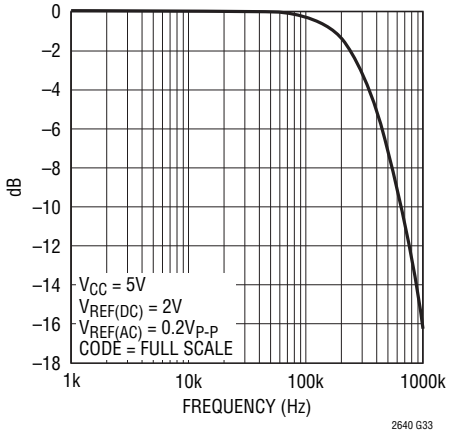
2640 G32

TYPICAL PERFORMANCE CHARACTERISTICS

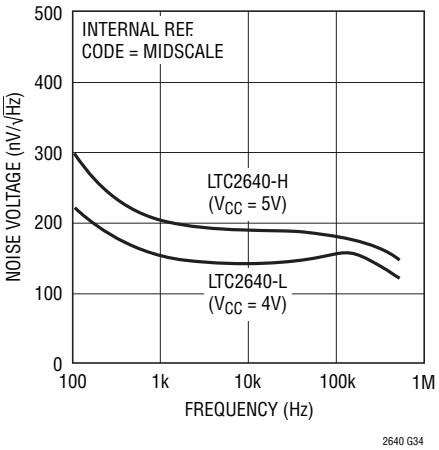
T_A = 25°C, unless otherwise noted.

LTC2640

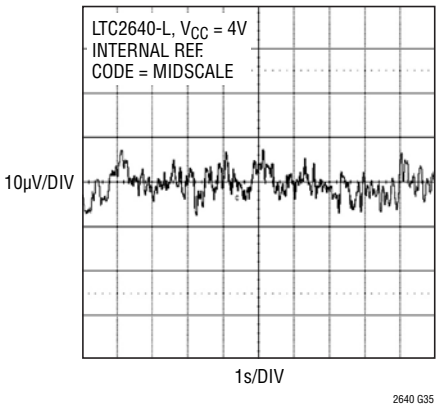
Multiplying Bandwidth



Noise Voltage vs Frequency



0.1Hz to 10Hz Voltage Noise



PIN FUNCTIONS

$\overline{CS}$/LD (Pin 1): Serial Interface Chip Select/Load Input. When $\overline{CS}$/LD is low, SCK is enabled for shifting data on SDI into the register. When $\overline{CS}$/LD is taken high, SCK is disabled and the specified command (see Table 1) is executed.

SCK (Pin 2): Serial Interface Clock Input. CMOS and TTL compatible.

SDI (Pin 3): Serial Interface Data Input. Data on SDI is clocked into the DAC on the rising edge of SCK. The LTC2640 accepts input word lengths of either 24- or 32-bits.

GND (Pin 4): Ground.

V_{CC} (Pin 5): Supply Voltage Input. 2.7V ≤ V_{CC} ≤ 5.5V (LTC2640-L) or 4.5V ≤ V_{CC} ≤ 5.5V (LTC2640-H). Bypass to GND with a 0.1µF capacitor.

REF (Pin 6): Reference Voltage Input or Output. When External Reference mode is selected, REF is an input (0V ≤ V_{REF} ≤ V_{CC}) where the voltage supplied sets the full-scale voltage. When Internal Reference is selected, the 10ppm/°C 1.25V (LTC2640-L) or 2.048V (LTC2640-H) internal reference is available at the pin. This output may be bypassed to GND with up to 10µF (0.33µF is recommended), and must be buffered when driving external DC load current.

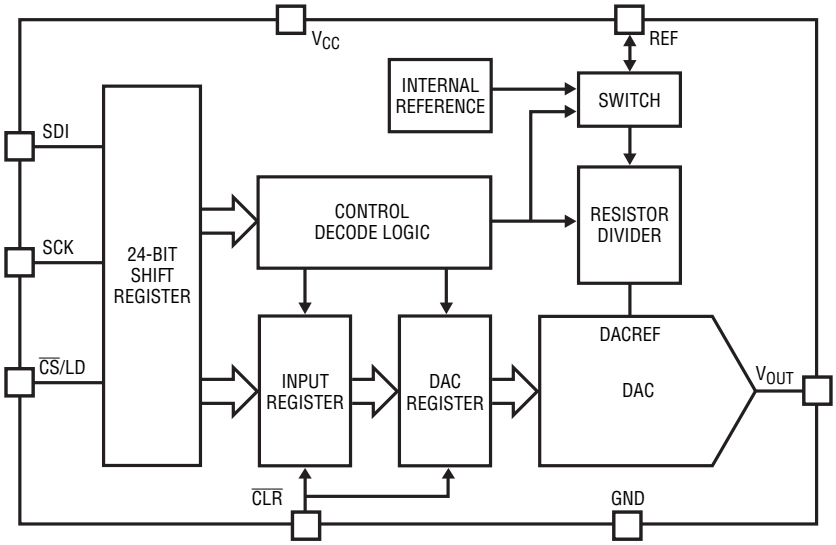
V_{OUT} (Pin 7): DAC Analog Voltage Output.

$\overline{CLR}$ (Pin 8, LTC2640-Z): Asynchronous Clear Input. A logic low at this level-triggered input clears all registers and causes the DAC voltage output to reset to Zero. CMOS and TTL compatible.

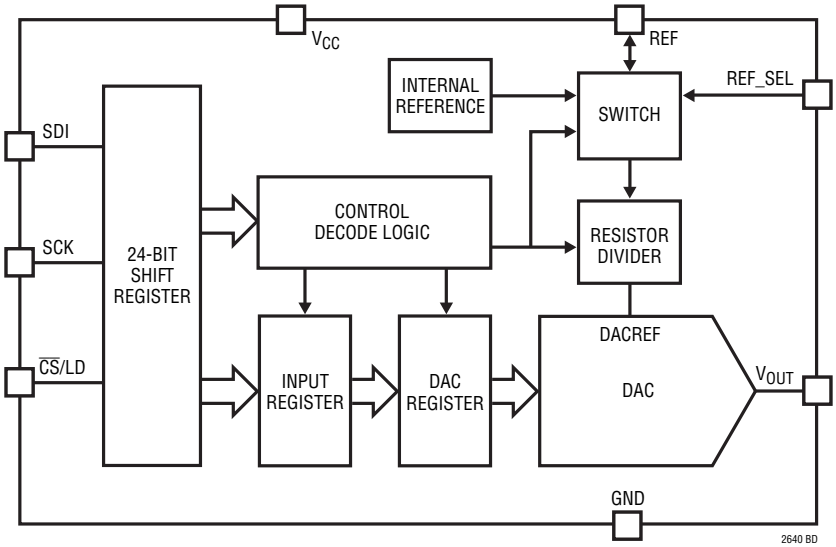
REF_SEL (Pin 8, LTC2640-M): Selects default Reference at power-up. Tie to V_{CC} to select the Internal Reference, or GND to select an External Reference. After power-up, the logic state at this pin is ignored and the reference may be changed only by software command.

BLOCK DIAGRAMS

LTC2640-Z



LTC2640-M



TIMING DIAGRAM

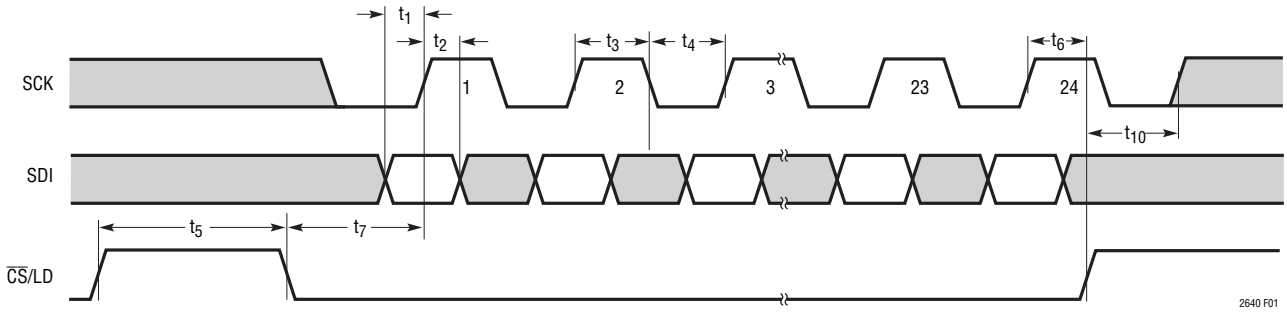


Figure 1. Serial Interface Timing

OPERATION

The LTC2640 is a family of single voltage-output DACs in 8-lead ThinSOT packages. Each DAC can operate rail-to-rail using an external reference, or with its full-scale voltage set by an integrated reference. 12 combinations of accuracy (12-, 10-, and 8-bit), power-on reset value (zero or mid-scale), and full-scale voltage (2.5V or 4.096V) are available. The LTC2640 is controlled using a 3-wire SPI/MICROWIRE compatible interface.

Power-On Reset

The LTC2640-HZ/LTC2640-LZ clear the output to zero-scale when power is first applied, making system initialization consistent and repeatable.

For some applications, downstream circuits are active during DAC power-up, and may be sensitive to nonzero outputs from the DAC during this time. The LTC2640 contains circuitry to reduce the power-on glitch: the analog output typically rises less than 5mV above zero-scale during power on if the power supply is ramped to 5V in 1ms or more. In general, the glitch amplitude decreases as the power supply ramp time is increased. See "Power-On Reset Glitch" in the Typical Performance Characteristics section.

The LTC2640-HM/LTC2640-LM provide an alternative reset, setting the output to mid-scale when power is first applied.

Default reference mode selection is described in the Reference Modes section.

Power Supply Sequencing

The voltage at REF (Pin 6) should be kept within the range $-0.3V \le V_{REF} \le V_{CC} + 0.3V$ (see Absolute Maximum Ratings). Particular care should be taken to observe these limits during power supply turn-on and turn-off sequences, when the voltage at V_{CC} (Pin 5) is in transition.

Transfer Function

The digital-to-analog transfer function is:

$$V_{OUT(IDEAL)} = \left(\frac{k}{2^N}\right) V_{REF}$$

where k is the decimal equivalent of the binary DAC input code, N is the resolution, and V_{REF} is either 2.5V (LTC2640-LM/LTC2640-LZ) or 4.096V (LTC2640-HM/LTC2640-HZ) when in Internal Reference mode, and the voltage at REF (Pin 6) when in External Reference mode.

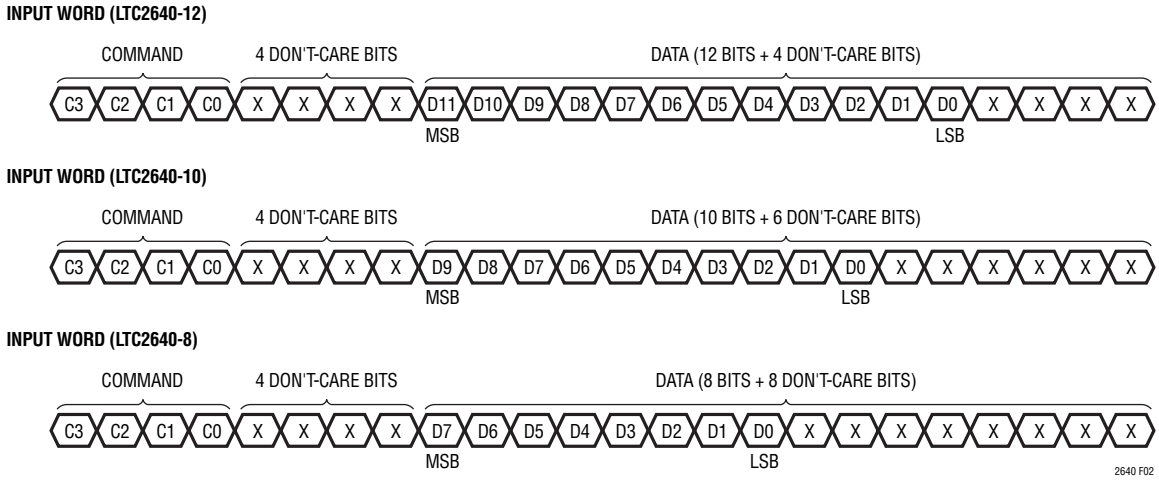


Figure 2. Command and Data Input Format

OPERATION

Serial Interface

The $\overline{CS}$/LD input is level triggered. When this input is taken low, it acts as a chip-select signal, enabling the SDI and SCK buffers and the input shift register. Data (SDI input) is transferred at the next 24 rising SCK edges. The 4-bit command, C3-C0, is loaded first, followed by 4 don't-cares bits, and finally the 16-bit data word. The data word comprises the 12-, 10- or 8-bit input code, ordered MSB-to-LSB, followed by 4, 6 or 8 don't-cares bits (LTC2640-12, LTC2640-10 and LTC2640-8 respectively; see Figure 2). Data can only be transferred to the device when the $\overline{CS}$/LD signal is low, beginning on the first rising edge of SCK. SCK may be high or low at the falling edge of $\overline{CS}$/LD. The rising edge of $\overline{CS}$/LD ends the data transfer and causes the device to execute the command specified in the 24-bit input sequence. The complete sequence is shown in Figure 3a.

The command (C3-C0) assignments are shown in Table 1. The first three commands in the table consist of write and update operations. A Write operation loads a 16-bit data word from the 24-bit shift register into the input register. In an Update operation, the input register is copied to the DAC register and converted to an analog voltage at the DAC output. Write to and Update combines the first two commands. The Update operation also powers up the DAC if it had been in power-down mode. The data path and registers are shown in the Block Diagram.

Table 1. Command Codes

COMMAND*				
C3	C2	C1	C0	
0	0	0	0	Write to Input Register
0	0	0	1	Update (Power-Up) DAC Register
0	0	1	1	Write to and Update (Power-Up) DAC Register
0	1	0	0	Power Down
0	1	1	0	Select Internal Reference
0	1	1	1	Select External Reference

*Command codes not shown are reserved and should not be used

While the minimum input sequence is 24-bits, it may optionally be extended to 32-bits to accommodate microprocessors that have a minimum word width of 16-bits (2-bytes). To use the 32-bit width, 8 don't-cares bits are transferred to the device first, followed by the 24-bit sequence described. Figure 3b shows the 32-bit sequence.

The 16-bit data word is ignored for all commands that do not include a Write operation.

Reference Modes

For applications where an accurate external reference is not available, the LTC2640 has a user-selectable, integrated reference. The LTC2640-LM/LTC2640-LZ provide a full-scale output of 2.5V. The LTC2640-HM/LTC2640-HZ provide a full-scale output of 4.096V. The internal reference can be useful in applications where the supply voltage is poorly regulated. Internal Reference mode can be selected by using command 0110, and is the power-on default for LTC2640-HZ/LTC2640-LZ, as well as for LTC2640-HM/LTC2640-LM when REF_SEL is tied high.

The 10ppm/°C, 1.25V (LTC2640-LM/LTC2640-LZ) or 2.048V (LTC2640-HM/LTC2640-HZ) internal reference is available at the REF pin. Adding bypass capacitance to the REF pin will improve noise performance; 0.33µF is recommended, and up to 10µF can be driven without oscillation. This output must be buffered when driving an external DC load current.

Alternatively, the DAC can operate in External Reference mode using command 0111. In this mode, an input voltage supplied externally to the REF pin provides the reference ($0V \le V_{REF} \le V_{CC}$) and the supply current is reduced. External Reference mode is the power-on default for LTC2640-HM/LTC2640-LM when REF_SEL is tied low.

The reference mode of LTC2640-HZ/LTC2640-LZ can be changed only by software command. The same is true for LTC2640-HM/LTC2640-LM after power-on, after which the logic state on REF_SEL is ignored.

Power-Down Mode

For power-constrained applications, the LTC2640's power-down mode can be used to reduce the supply current whenever the DAC output is not needed. When in power-down, the buffer amplifier, bias circuit, and reference circuit are disabled and draw essentially zero current. The DAC output is put into a HIGH-impedance state, and the output pin is passively pulled to ground through a 200k

OPERATION

resistor. Input and DAC register contents are not disturbed during power-down.

The DAC can be put into power-down mode by using command 0100. The supply current is reduced to 1.8µA maximum (C and I grades) and the REF pin becomes HIGH impedance (typically > 1GΩ).

Normal operation resumes after executing any command that includes a DAC update, as shown in Table 1. The DAC is powered up and its voltage output is updated. Normal settling is delayed while the bias, reference, and amplifier circuits are re-enabled. When the REF pin output is bypassed to GND with 1nF or less, the power-up delay time is 20µs for settling to 12-bits. This delay increases to 200µs for 0.33µF, and 10ms for 10µF.

Voltage Output

The LTC2640's integrated rail-to-rail amplifier has guaranteed load regulation when sourcing or sinking up to 10mA at 5V, and 5mA at 3V.

Load regulation is a measure of the amplifier's ability to maintain the rated voltage accuracy over a wide range of load current. The measured change in output voltage per change in forced load current is expressed in LSB/mA.

DC output impedance is equivalent to load regulation, and may be derived from it by simply calculating a change in units from LSB/mA to ohms. The amplifier's DC output impedance is 0.1Ω when driving a load well away from the rails.

When drawing a load current from either rail, the output voltage headroom with respect to that rail is limited by the 50Ω typical channel resistance of the output devices (e.g., when sinking 1mA, the minimum output voltage is 50Ω • 1mA, or 50mV). See the graph "Headroom at Rails vs. Output Current" in the Typical Performance Characteristics section.

The amplifier is stable driving capacitive loads of up to 500pF.

Rail-to-Rail Output Considerations

In any rail-to-rail voltage output device, the output is limited to voltages within the supply range.

Since the analog output of the DAC cannot go below ground, it may limit the lowest codes, as shown in Figure 4b. Similarly, limiting can occur near full-scale when the REF pin is tied to V_{CC}. If $V_{REF} = V_{CC}$ and the DAC full-scale error (FSE) is positive, the output for the highest codes limits at V_{CC}, as shown in Figure 4c. No full-scale limiting can occur if V_{REF} is less than V_{CC} – FSE.

Offset and linearity are defined and tested over the region of the DAC transfer function where no output limiting can occur.

Board Layout

The PC board should have separate areas for the analog and digital sections of the circuit. A single, solid ground plane should be used, with analog and digital signals carefully routed over separate areas of the plane. This keeps digital signals away from sensitive analog signals and minimizes the interaction between digital ground currents and the analog section of the ground plane. The resistance from the LTC2640 GND pin to the ground plane should be as low as possible. Resistance here will add directly to the effective DC output impedance of the device (typically 0.1Ω). Note that the LTC2640 is no more susceptible to this effect than any other parts of this type; on the contrary, it allows layout-based performance improvements to shine rather than limiting attainable performance with excessive internal resistance.

Another technique for minimizing errors is to use a separate power ground return trace on another board layer. The trace should run between the point where the power supply is connected to the board and the DAC ground pin. Thus the DAC ground pin becomes the common point for analog ground, digital ground, and power ground. When the LTC2640 is sinking large currents, this current flows out the ground pin and directly to the power ground trace without affecting the analog ground plane voltage.

It is sometimes necessary to interrupt the ground plane to confine digital ground currents to the digital portion of the plane. When doing this, make the gap in the plane only as long as it needs to be to serve its purpose and ensure that no traces cross over the gap.

OPERATION

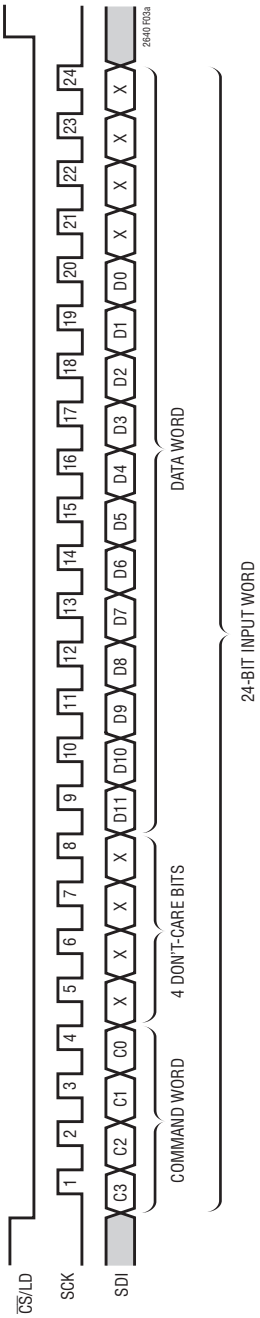


Figure 3a. LTC2640-12 24-Bit Load Sequence (Minimum Input Word). LTC2640-10 SDI Data Word: 10-Bit Input Code + 6 Don't-Cares Bits; LTC2640-8 SDI Data Word: 8-Bit Input Code + 8 Don't-Cares Bits

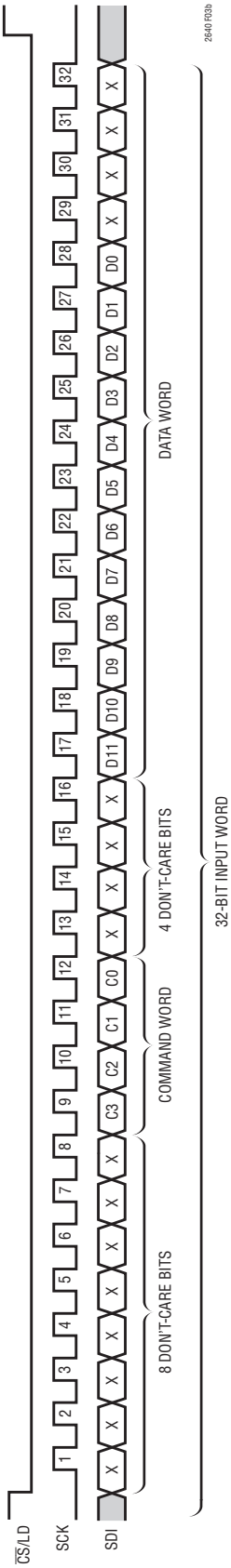


Figure 3b. LTC2640-12 32-Bit Load Sequence LTC2640-10 SDI Data Word: 10-Bit Input Code + 6 Don't-Cares Bits; LTC2640-8 SDI Data Word: 8-Bit Input Code + 8 Don't-Cares Bits

OPERATION

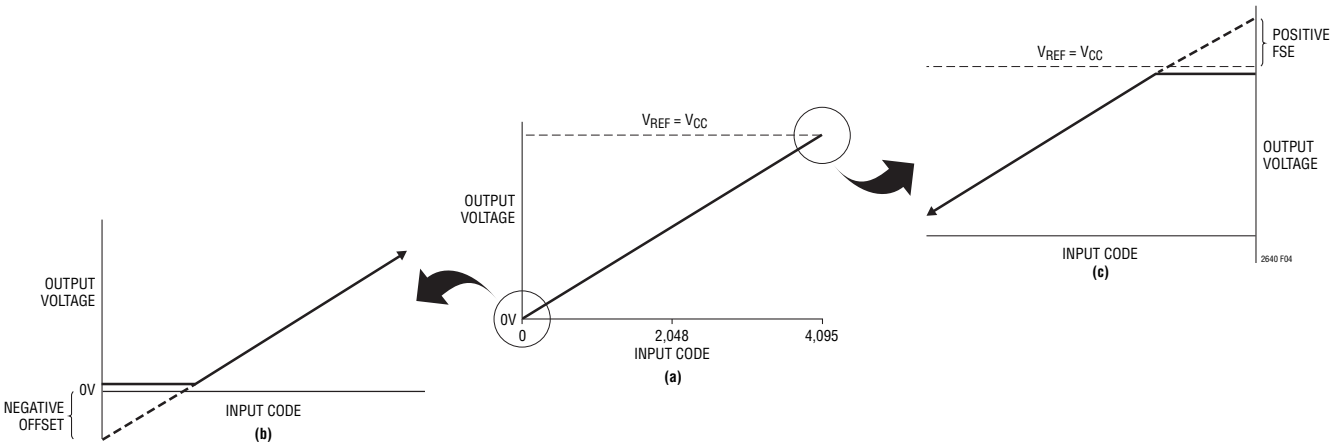
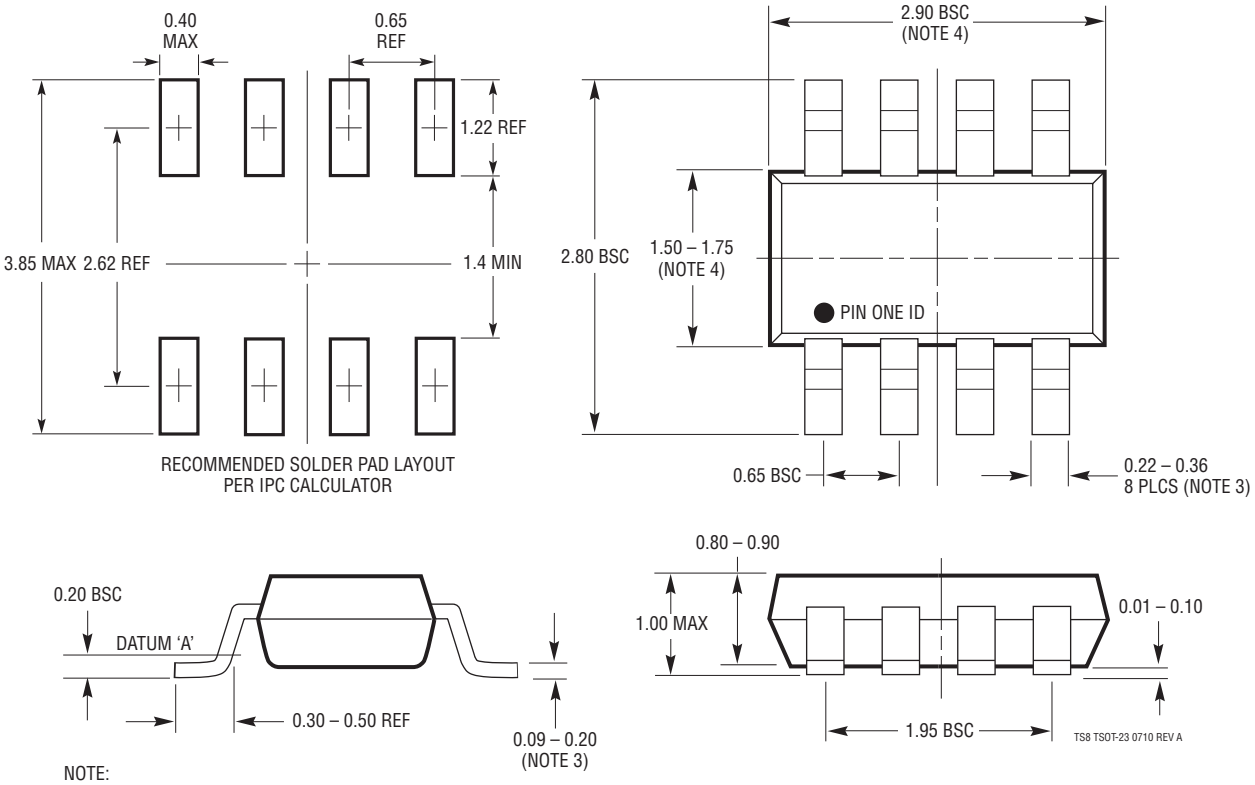


Figure 4. Effects of Rail-to-Rail Operation on a DAC Transfer Curve (Shown for 12-Bits)
(a) Overall Transfer Function
(b) Effect of Negative Offset for Codes Near Zero
(c) Effect of Positive Full-Scale Error for Codes Near Full-Scale

PACKAGE DESCRIPTION

Please refer to http://www.linear.com/designtools/packaging/ for the most recent package drawings.

TS8 Package
8-Lead Plastic TSOT-23
(Reference LTC DWG # 05-08-1637 Rev A)



NOTE:
1. DIMENSIONS ARE IN MILLIMETERS
2. DRAWING NOT TO SCALE
3. DIMENSIONS ARE INCLUSIVE OF PLATING
4. DIMENSIONS ARE EXCLUSIVE OF MOLD FLASH AND METAL BURR
5. MOLD FLASH SHALL NOT EXCEED 0.254mm
6. JEDEC PACKAGE REFERENCE IS MO-193

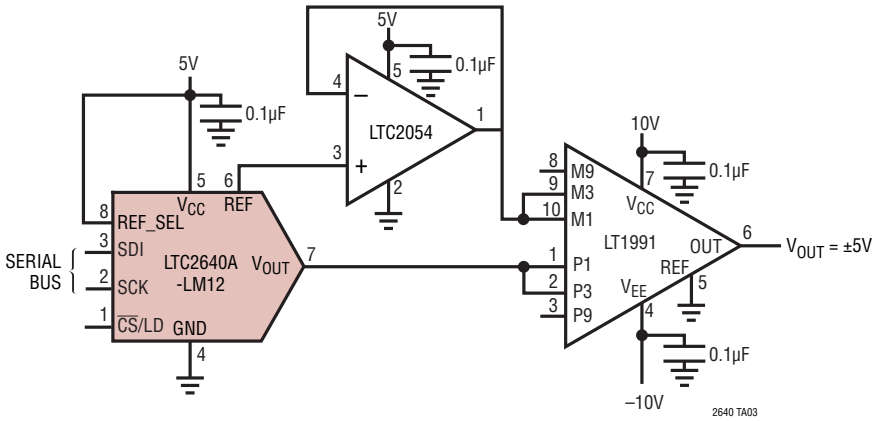
REVISION HISTORY (Revision history begins at Rev C)

REV	DATE	DESCRIPTION	PAGE NUMBER
C	10/13	Updated TS8 package drawing to Rev A.	22

Information furnished by Linear Technology Corporation is believed to be accurate and reliable. However, no responsibility is assumed for its use. Linear Technology Corporation makes no representation that the interconnection of its circuits as described herein will not infringe on existing patent rights.

TYPICAL APPLICATION

Programmable ±5V Output



RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LTC1663	Single 10-Bit V_{OUT} DAC in SOT-23	V_{CC} = 2.7V to 5.5V, 60µA, Internal Reference, SMBus Interface
LTC1669	Single 10-Bit V_{OUT} DAC in SOT-23	V_{CC} = 2.7V to 5.5V, 60µA, Internal Reference, I^2C Interface
LTC2360/LTC2362/ LTC2365/LTC2366	12-Bit SAR ADCs in TSOT23-6/TSOT23-8 Packages	100ksps/250ksps/500ksps/1Msps/3Msps Output Rates
LTC2450/LTC2452	16-Bit Single-Ended/Differential Delta Sigma ADCs	SPI Interface, Tiny DFN Packages, 60Hz Output Rate
LTC2451/LTC2453	16-Bit Single-Ended/Differential Delta Sigma ADCs	I^2C Interface, Tiny DFN and TSOT23-8 Packages, 60Hz Output Rate
LTC2600/LTC2610/LTC2620	Octal 16-/14-/12-Bit V_{OUT} DACs in 16-Lead SSOP	250µA per DAC, 2.5V to 5.5V Supply Range, Rail-to-Rail Output, SPI Serial Interface
LTC2601/LTC2611/LTC2621	Single 16-/14-/12-Bit V_{OUT} DACs in 10-Lead DFN	300µA per DAC, 2.5V to 5.5V Supply Range, Rail-to-Rail Output, SPI Serial Interface
LTC2602/LTC2612/LTC2622	Dual 16-/14-/12-Bit V_{OUT} DACs in 8-Lead MSOP	300µA per DAC, 2.5V to 5.5V Supply Range, Rail-to-Rail Output, SPI Serial Interface
LTC2604/LTC2614/LTC2624	Quad 16-/14-/12-Bit V_{OUT} DACs in 16-Lead SSOP	250µA per DAC, 2.5V to 5.5V Supply Range, Rail-to-Rail Output, SPI Serial Interface
LTC2605/LTC2615/LTC2625	Octal 16-/14-/12-Bit V_{OUT} DACs with I^2C Interface	250µA per DAC, 2.5V to 5.5V Supply Range, Rail-to-Rail Output, I^2C Interface
LTC2606/LTC2616/LTC2626	Single 16-/14-/12-Bit V_{OUT} DACs with I^2C Interface	270µA per DAC, 2.5V to 5.5V Supply Range, Rail-to-Rail Output, I^2C Interface
LTC2609/LTC2619/LTC2629	Quad 16-/14-/12-Bit V_{OUT} DACs with I^2C Interface	250µA per DAC, 2.5V to 5.5V Supply Range, Rail-to-Rail Output with Separate V_{REF} Pins for Each DAC
LTC2630	Single 12-/10-/8-Bit V_{OUT} DACs with 10ppm/°C Reference in SC70	180µA per DAC, 2.7V to 5.5V Supply Range, 10ppm/°C Reference, Rail-to-Rail Output, SPI Interface
LTC2631	Single 12-/10-/8-Bit I^2C V_{OUT} DACs with 10ppm/°C Reference in ThinSOT	180µA per DAC, 2.7V to 5.5V Supply Range, 10ppm/°C Reference, Selectable External Ref. Mode, Rail-to-Rail Output, I^2C Interface

Linear Technology Corporation
1630 McCarthy Blvd., Milpitas, CA 95035-7417
(408) 432-1900 • FAX: (408) 434-0507 • www.linear.com/LTC2640
LT 1013 REV C • PRINTED IN USA
© LINEAR TECHNOLOGY CORPORATION 2008